

### Introduction of Semi-power & small-size low RON MOSFET

#### Expanding lineup of semi-power and small-size MOSFET with low RON

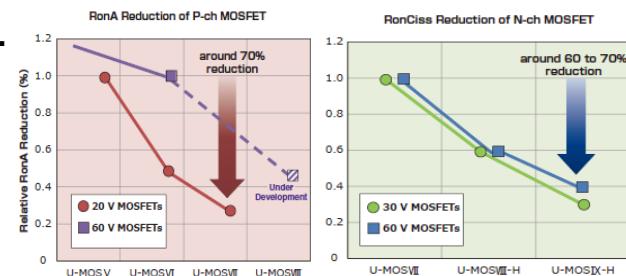
Toshiba uses cutting-edge technology to achieve low RON characteristics, and packages are available in industry standard 2x2 mm and 2.9x2.4 mm sizes.

It contributes to the low power consumption and downsizing required for battery-powered devices such as smartphones and wearable devices.

#### The low RON characteristic contributes to reducing the burden on heat dissipation design.

Toshiba uses advanced trench process technology to miniaturize its cell structure to achieve a low RON characteristic. The latest-generation trench processes U-MOS VII and U-MOS IX succeeded in reducing on-resistance per unit area by up to 70 % compared to the previous-generation processes.

This improvement is effective in reducing conduction loss.



#### Contributing to energy savings in low loss load switch applications

Low loss and compact semiconductor devices are essential in order to reduce power consumption of power supply system such as rapid charge and USB PD as typified by mobile devices and power supply systems in the sets themselves. SSM6K513NU, a MOSFET using Toshiba's U-MOS IX process, achieves excellent low on-resistance characteristics and helps reduce temperature rise due to conduction loss.

#### Features

- Low on-resistance: 12 ~ 198 mΩ @4.5 V
- Wide voltage rating Lineup: VDSS = -30 ~ 100 V

#### MOSFET selection table

##### [N-Channel MOSFETs]

Part number	Product summary	Package	VDSS (V)	VGSS (V)	ID (A)	RON max (mΩ)		Ciss (pF)	Buy Online
						1.8V	4.5V		
<a href="#">SSM6K513NU</a>	MOSFET N-CH 30V/15A UDFN6B	UDFN6B (2.0x2.0mm)	30	±20	15	-	12	1130	
<a href="#">SSM6K514NU</a>	MOSFET N-CH 40V/12A UDFN6B	UDFN6B (2.0x2.0mm)	40	±20	12	-	17.3	1110	
<a href="#">SSM6K341NU</a>	MOSFET N-CH 60V/6A UDFN6B	UDFN6B (2.0x2.0mm)	60	±20	6	-	51	550	
<a href="#">SSM6K361NU</a>	MOSFET N-CH 100V/3.5A UDFN6B	UDFN6B (2.0x2.0mm)	100	±20	3.5	-	92	430	
<a href="#">SSM6K387NU</a>	MOSFET N-CH 100V/2A UDFN6B	UDFN6B (2.0x2.0mm)	100	±20	2	-	198	242	
<a href="#">SSM6K517NU</a>	MOSFET N-CH 30V/6A UDFN6B	UDFN6B (2.0x2.0mm)	30	+12/-8	6	82	39	310	
<a href="#">SSM6K518NU</a>	MOSFET N-CH 20V/6A UDFN6B	UDFN6B (2.0x2.0mm)	20	+8/-6	6	74	33	410	
<a href="#">SSM6N67NU</a>	MOSFET 2N-CH 30V/4A UDFN6	UDFN6 (2.0x2.0mm)	30	+12/-8	4	-	39.1	310	
<a href="#">SSM3K333R</a>	MOSFET N-CH 30V/6A SOT-23F	SOT-23F (2.9x2.4mm)	30	±20	6	-	42	436	
<a href="#">SSM3K345R</a>	MOSFET N-CH 20V/4A SOT-23F	SOT-23F (2.9x2.4mm)	20	±8	4	74	33	410	
<a href="#">SSM10N961L</a>	N-CH Common drain FET 30V/9A	TCSPAG (3.37x1.47mm)	30 <sup>(*)1</sup>	±20	9	-	17.6 <sup>(*)2</sup>	-	

(\*)1 Source – source voltage, (\*)2 Source – source on-resistance

##### [P-Channel MOSFETs]

Part number	Product summary	Package	VDSS (V)	VGSS (V)	ID (A)	RON max (mΩ)		Ciss (pF)	Buy Online
						1.5V	4.5V		
<a href="#">SSM6J511NU</a>	MOSFET P-CH 12V/14A UDFN6B	UDFN6B (2.0x2.0mm)	-12	±10	-14	-	10	3350	
<a href="#">SSM6J507NU</a>	MOSFET P-CH 30V/10A UDFN6B	UDFN6B (2.0x2.0mm)	-30	+20/-25	-10	-	28	1150	
<a href="#">SSM6P69NU</a>	MOSFET 2P-CH 20V/4A UDFN6	UDFN6 (2.0x2.0mm)	-20	+6/-12	-4	-	56	480	
<a href="#">SSM3J374R</a>	MOSFET P-CH 30V/4A SOT-23F	SOT-23F (2.9x2.4mm)	-30	+10/-20	-4	-	105	1400	
<a href="#">SSM3J378R</a>	MOSFET P-CH 20V/6A SOT-23F	SOT-23F (2.9x2.4mm)	-20	+6/-8	-6	88.4	29.8	560	

## LINK

- Small package MOSFET product introduction page [Click](#)
- Application Notes [Click](#)
- Frequently Asked Questions (FAQ) of MOSFET [Click](#)
- Online distributor purchase, inventory search page [Click](#)
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